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(12) **United States Design Patent** (10) **Patent No.:** **US D968,368 S**  
**Li** (45) **Date of Patent:** **\*\* Nov. 1, 2022**

(54) **EARPHONE**

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(52) **U.S. Cl.**  
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381/380-381  
CPC ..... H04R 1/10; H04R 25/00; H04R 25/02;  
H04R 1/1066; H04R 1/1016; H04R  
5/033; H04R 5/0335; H04R 1/1083;  
H04R 1/1058; H04R 1/1091  
See application file for complete search history.

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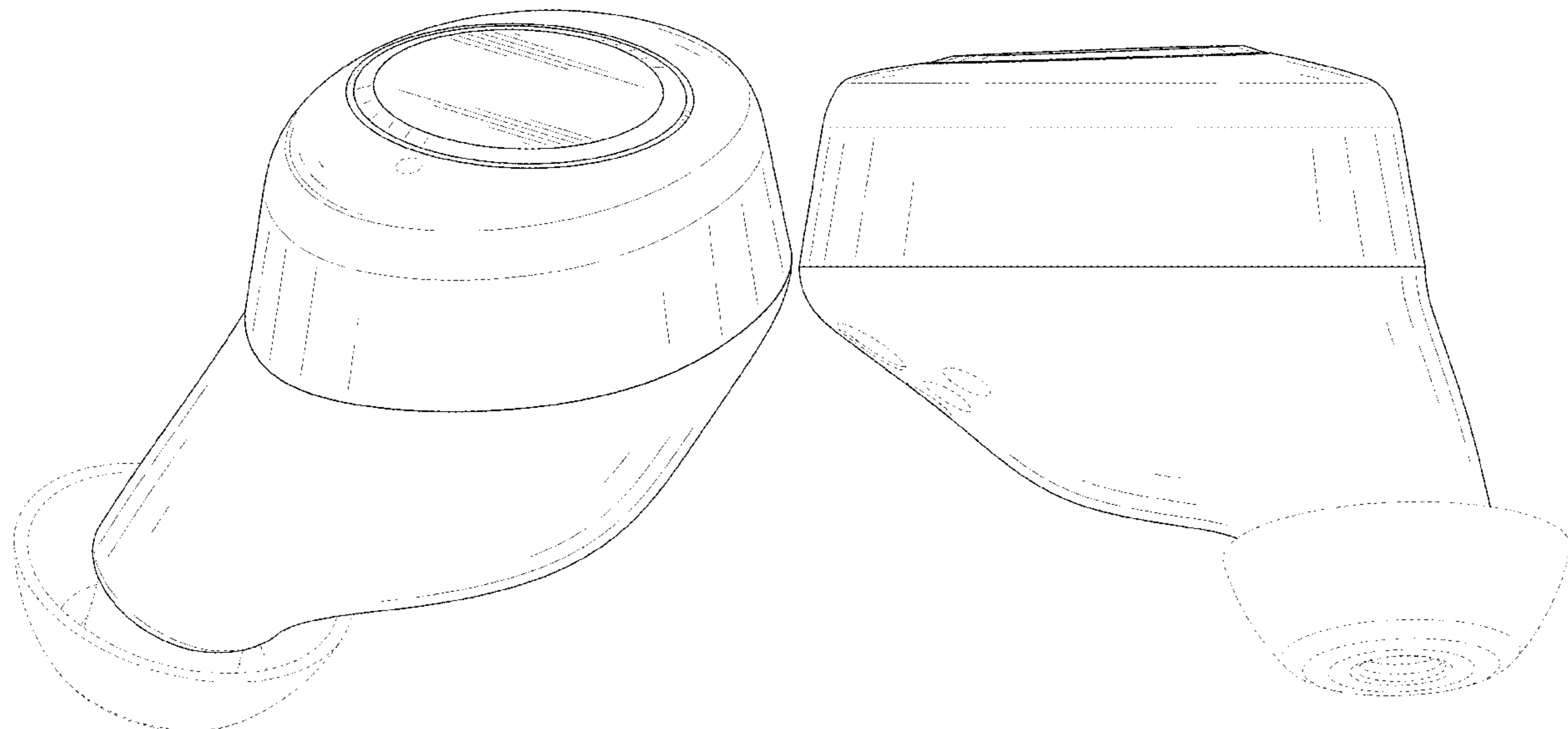
(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of an earphone showing my new design;  
FIG. 2 is another perspective view thereof;  
FIG. 3 is a front elevational view thereof;  
FIG. 4 is a rear elevational view thereof;  
FIG. 5 is a left side elevational view thereof;  
FIG. 6 is a right side elevational view thereof;  
FIG. 7 is a top plan view thereof; and,  
FIG. 8 is a bottom plan view thereof.  
The broken lines in the drawings depict portions of the earphone that form no part of the claimed design.

**1 Claim, 8 Drawing Sheets**



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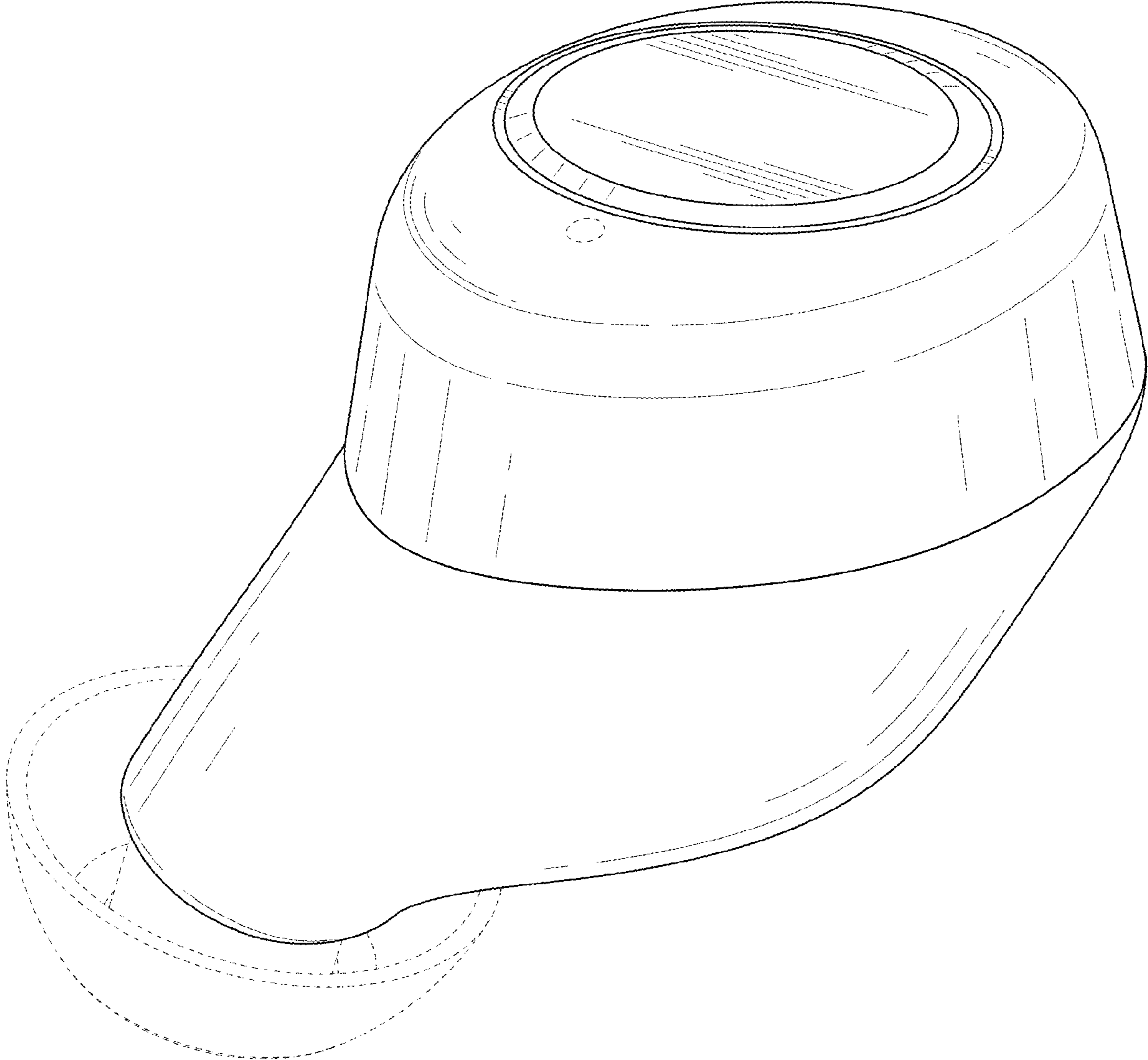


FIG. 1

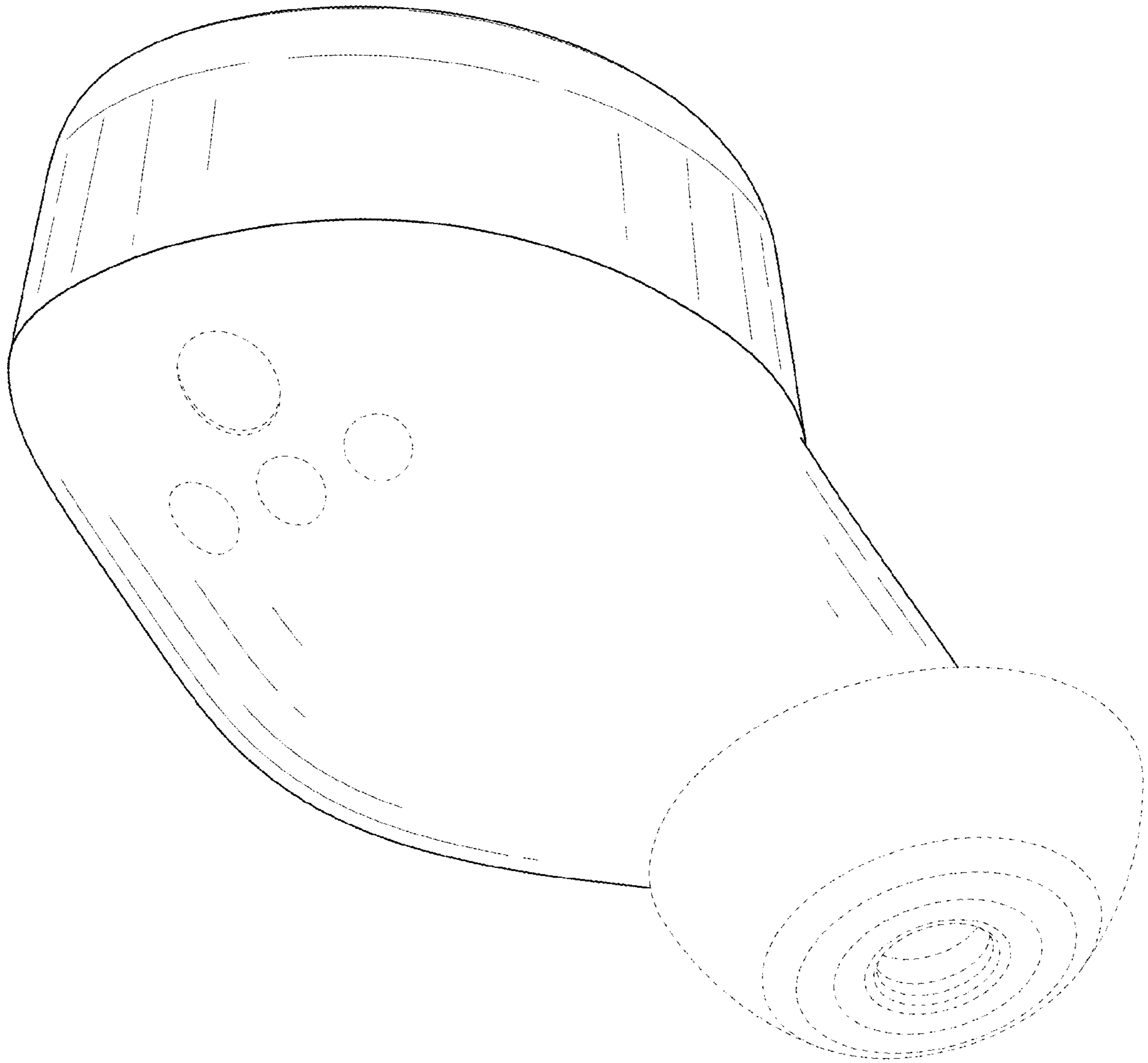


FIG. 2

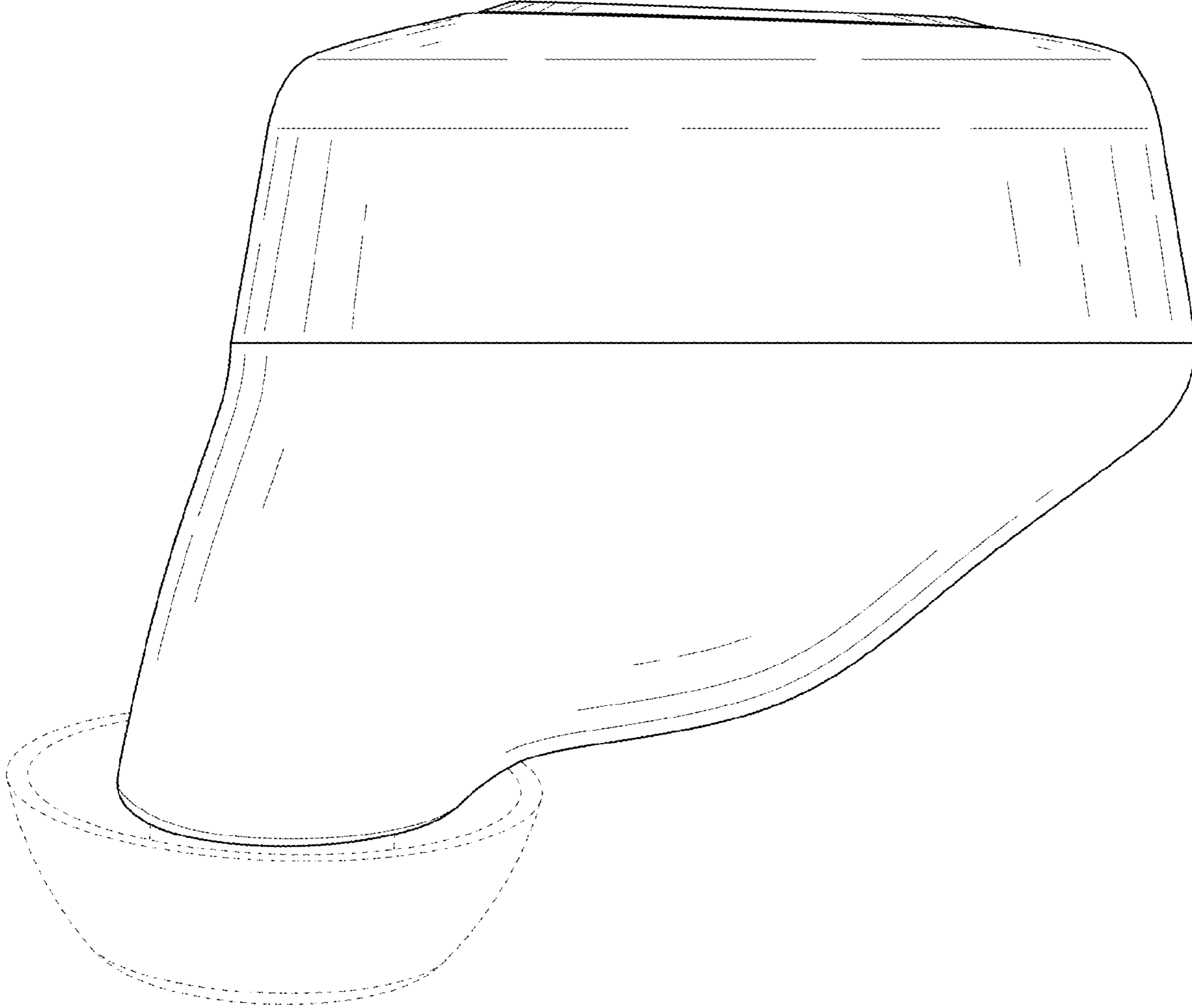


FIG. 3

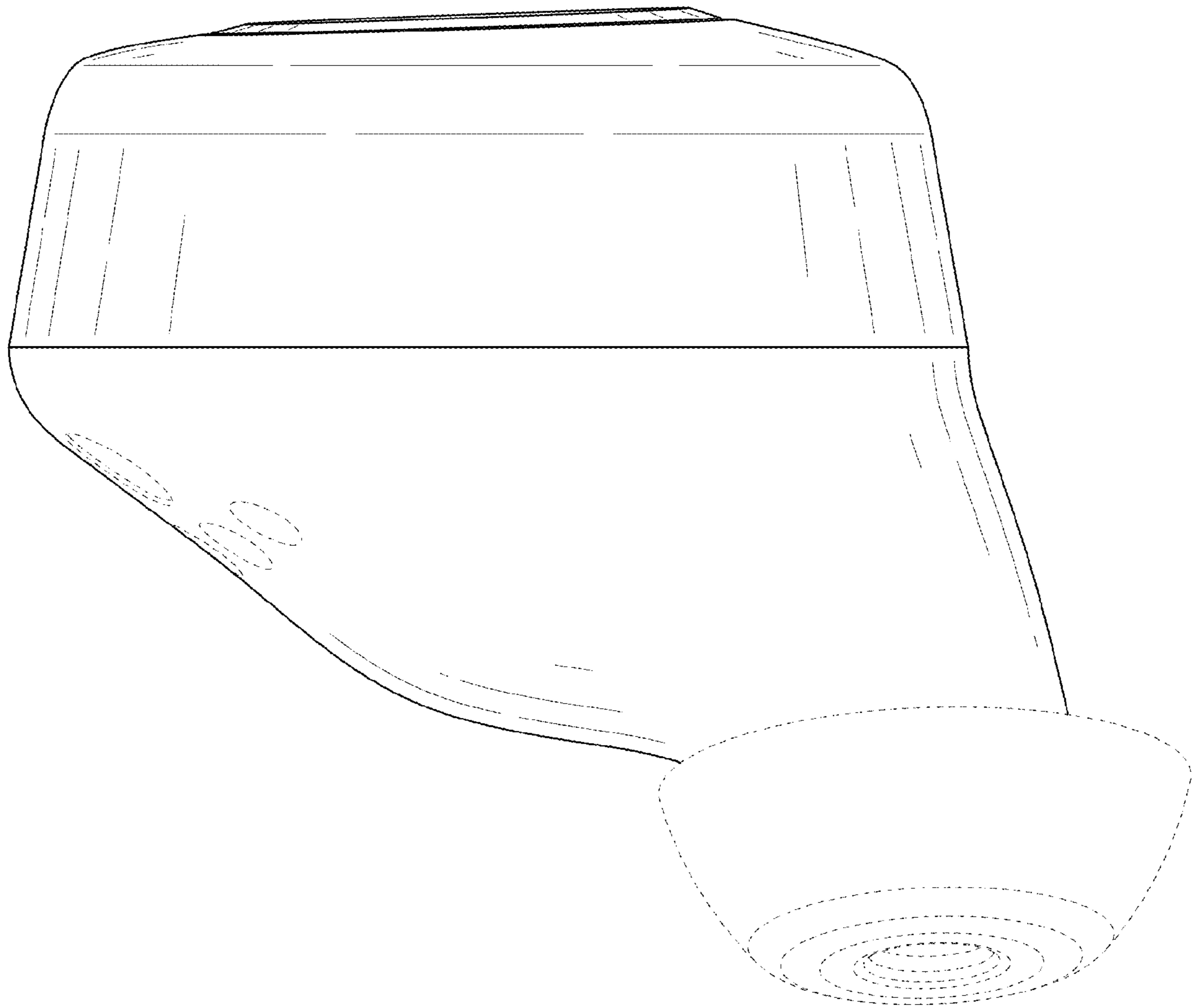


FIG. 4

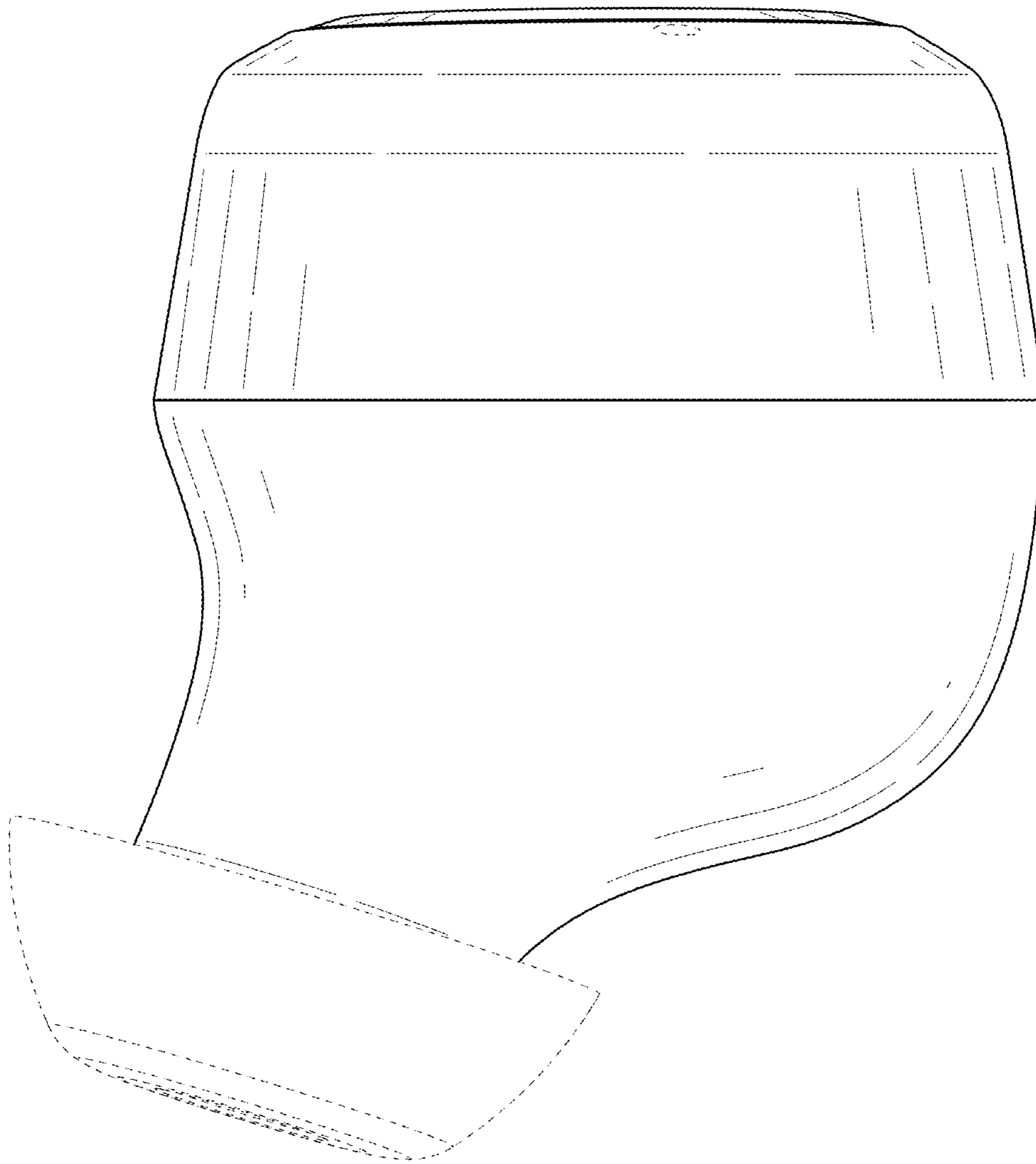


FIG. 5

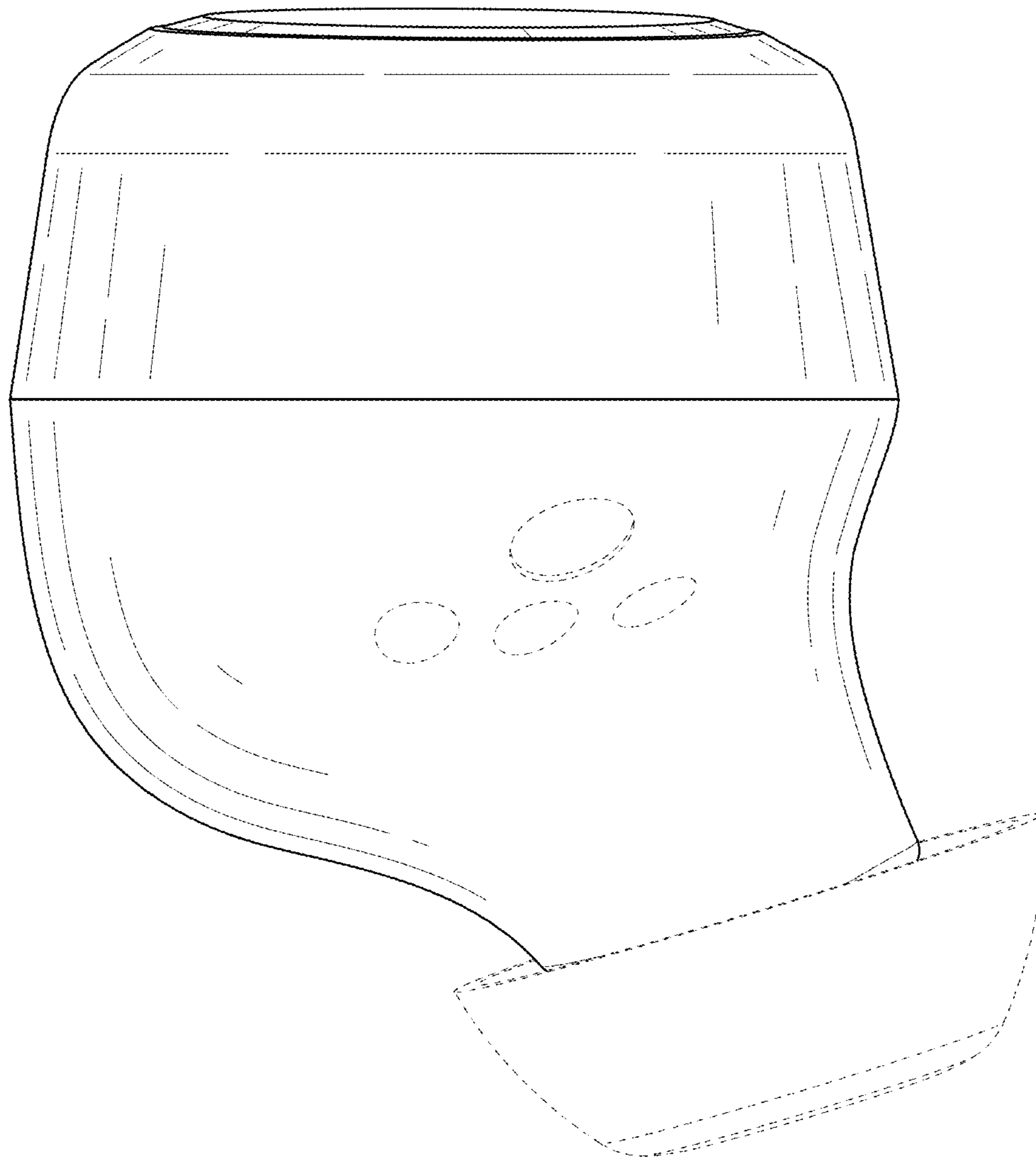


FIG. 6



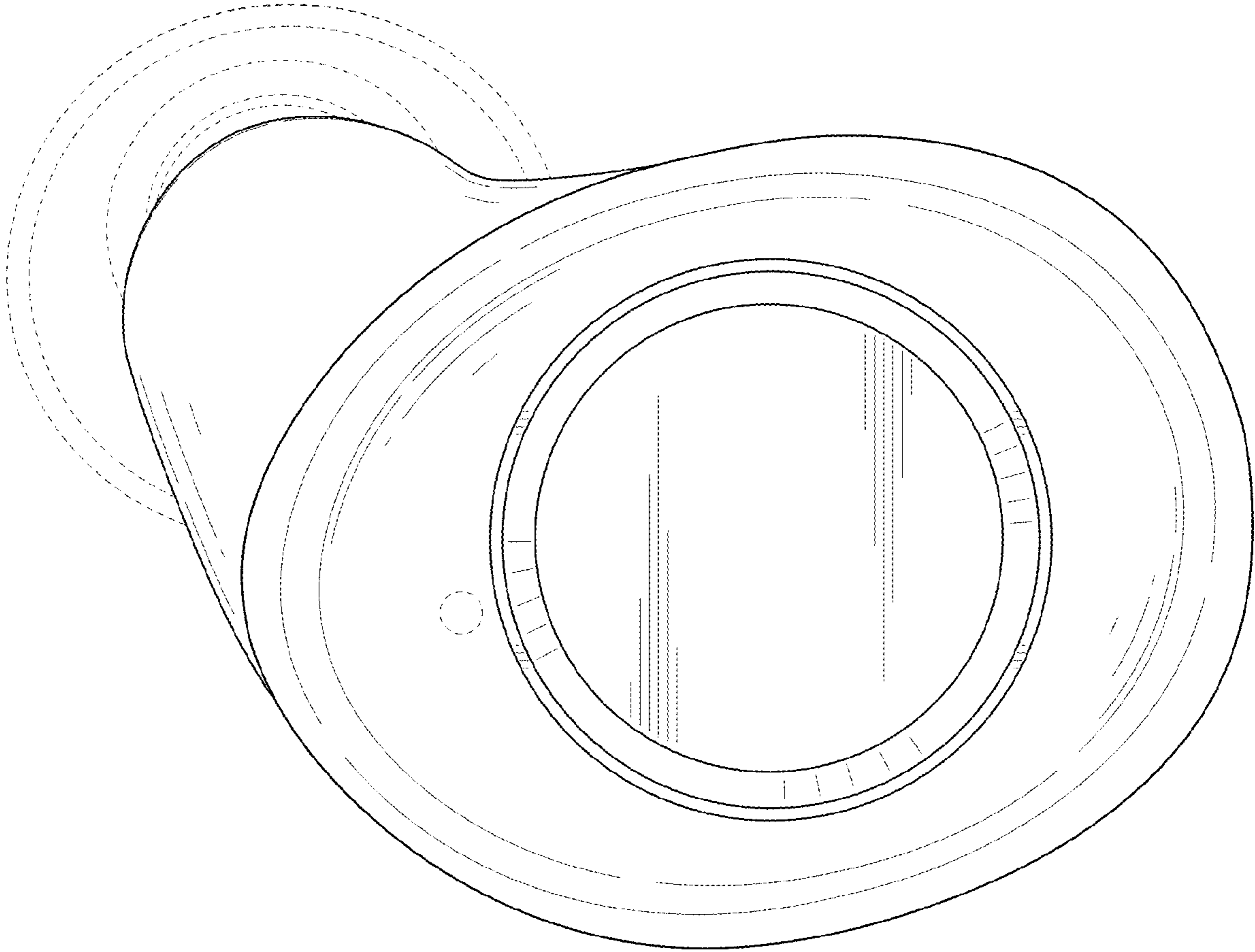


FIG. 7

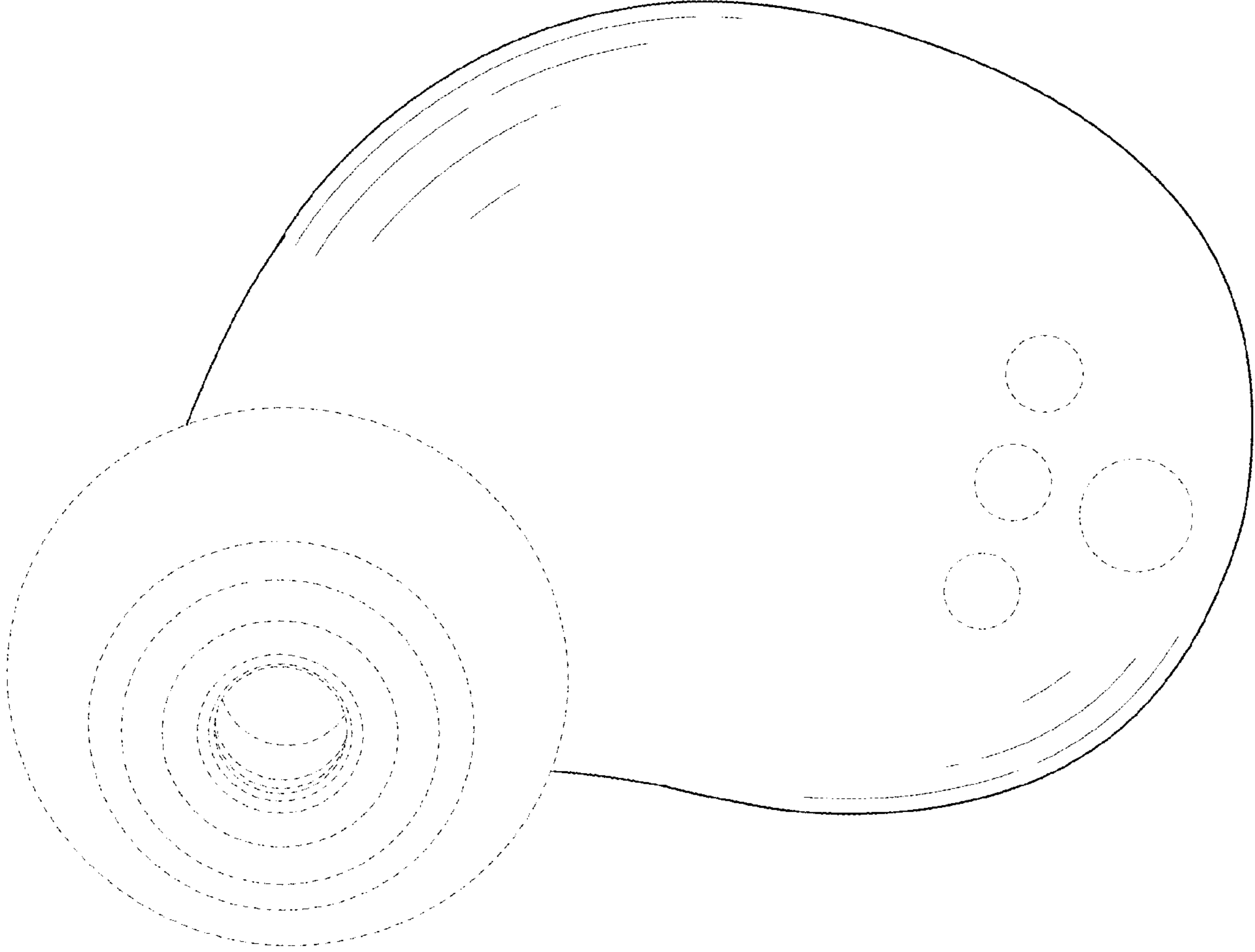


FIG. 8